

# PROPERTIES OF E-BEAM EVAPORATED TITANIUM OXIDE THIN FILM

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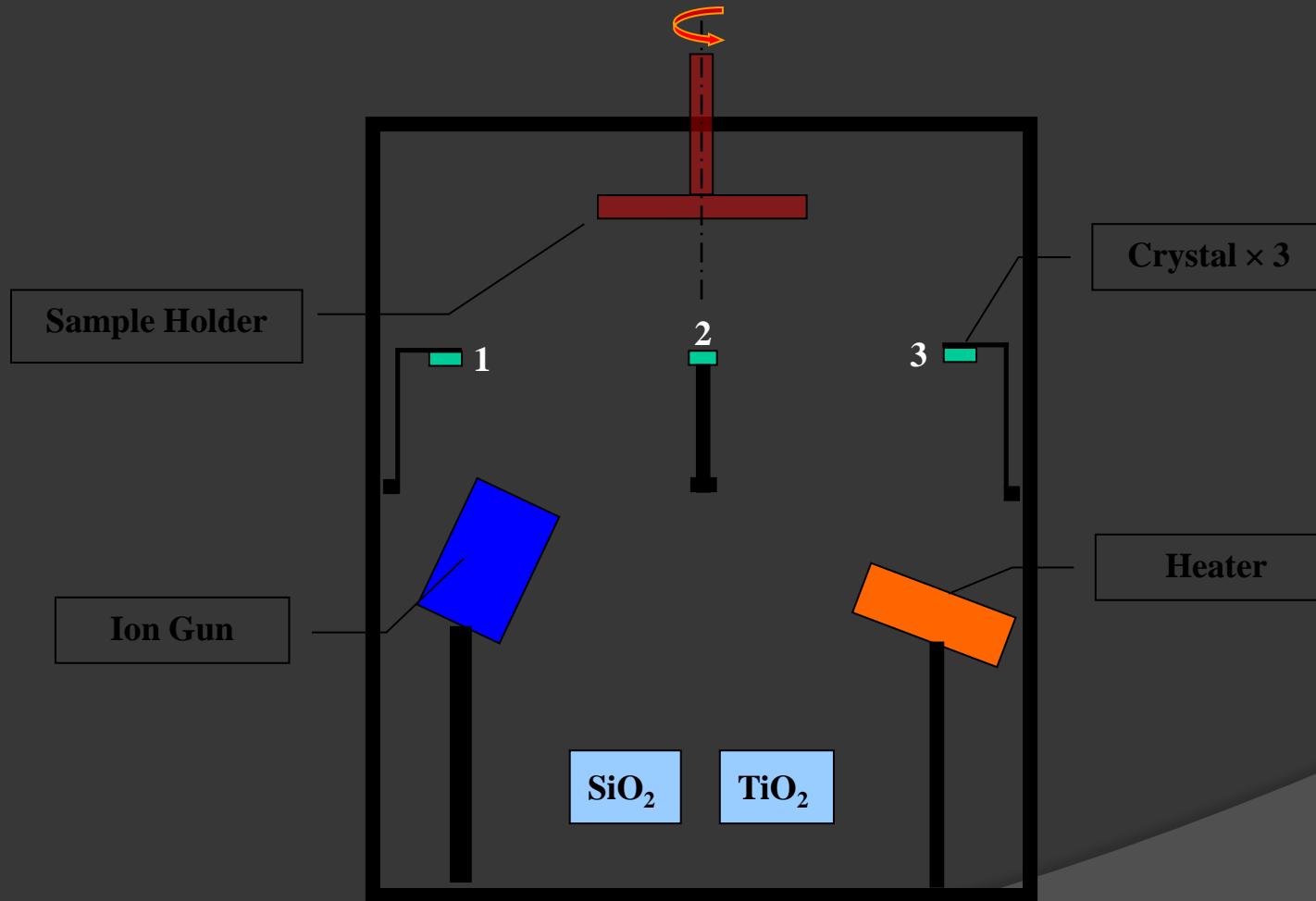
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# Introduction

Titanium oxide ( $\text{TiO}_2$ ) thin film has been widely used as optical coatings due to its high index of refraction. It is well known that structures and properties of  $\text{TiO}_2$  films are highly dependent on the processing techniques. E-beam evaporation has long been recognized as a practical way of depositing optical thin films. However, preparing a homogenous  $\text{TiO}_2$  film with this technique is still a challenge. One of the difficulties of getting a structurally uniform  $\text{TiO}_2$  film lies in the fact of its low phase transformation temperature. It is vital to find a fast and non-destructive way to monitor and evaluate the film optical quality. It is also important to tail the film stress at will to satisfy mechanical requirements for MEMs devices, such as vertical cavity surface emission laser (VCSEL). To this end, the stress and structural homogeneity of e-beam evaporated  $\text{TiO}_2$  films will be examined and discussed in this research.

# Deposition Chamber



## Deposition Process

**Table 1. Experiment Conditions for Structural Study**

<b>Deposition Rate (<math>\text{\AA}/\text{s}</math>)</b>	<b>2.0</b>
<b>Chamber Pressure (Torr)</b>	<b><math>2.5 \times 10^{-4}</math></b>
<b>Anode Voltage (V)</b>	<b>130</b>
<b>Anode Current (A)</b>	<b>1.0</b>

**Table 2 Experimental Conditions for Stress Study**

<b>Deposition Rate (<math>\text{\AA}/\text{s}</math>)</b>	<b>2.0</b>	<b>2.5</b>	<b>3.0</b>
<b>Chamber Pressure (Torr)</b>	<b><math>2.0 \times 10^{-4}</math></b>	<b><math>2.5 \times 10^{-4}</math></b>	<b><math>3.0 \times 10^{-4}</math></b>
<b>Anode Voltage (V)</b>	<b>100</b>	<b>130</b>	<b>160</b>
<b>Anode Current (A)</b>	<b>1.0</b>	<b>2.5</b>	<b>3.5</b>

# Model and Its Analyses

$$\rho = \frac{R^P}{R^S} = \text{Tan} \psi \cdot e^{j\Delta} = f(n_i, k_i, d_i \dots)$$

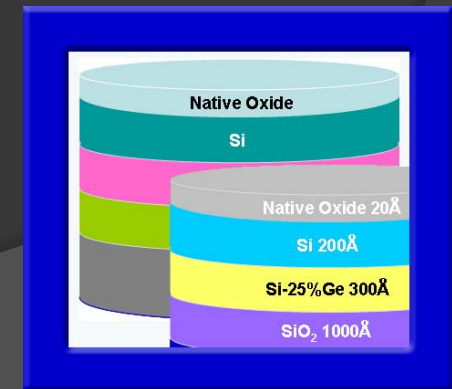
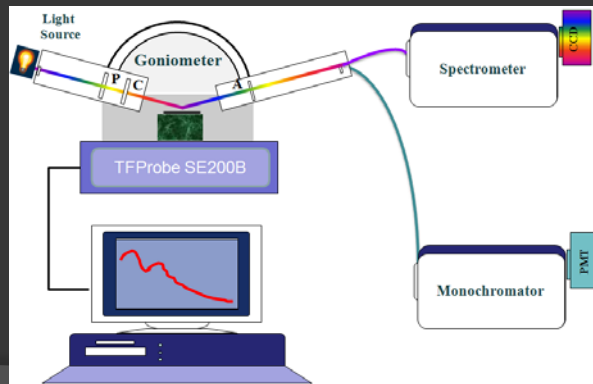
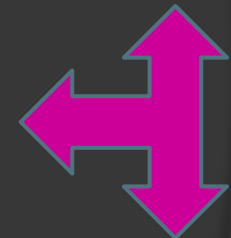
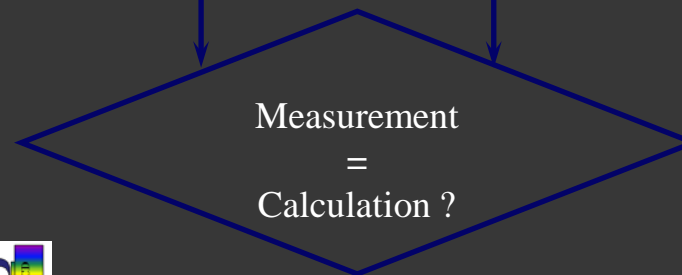
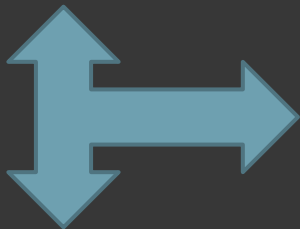
## Measured Data



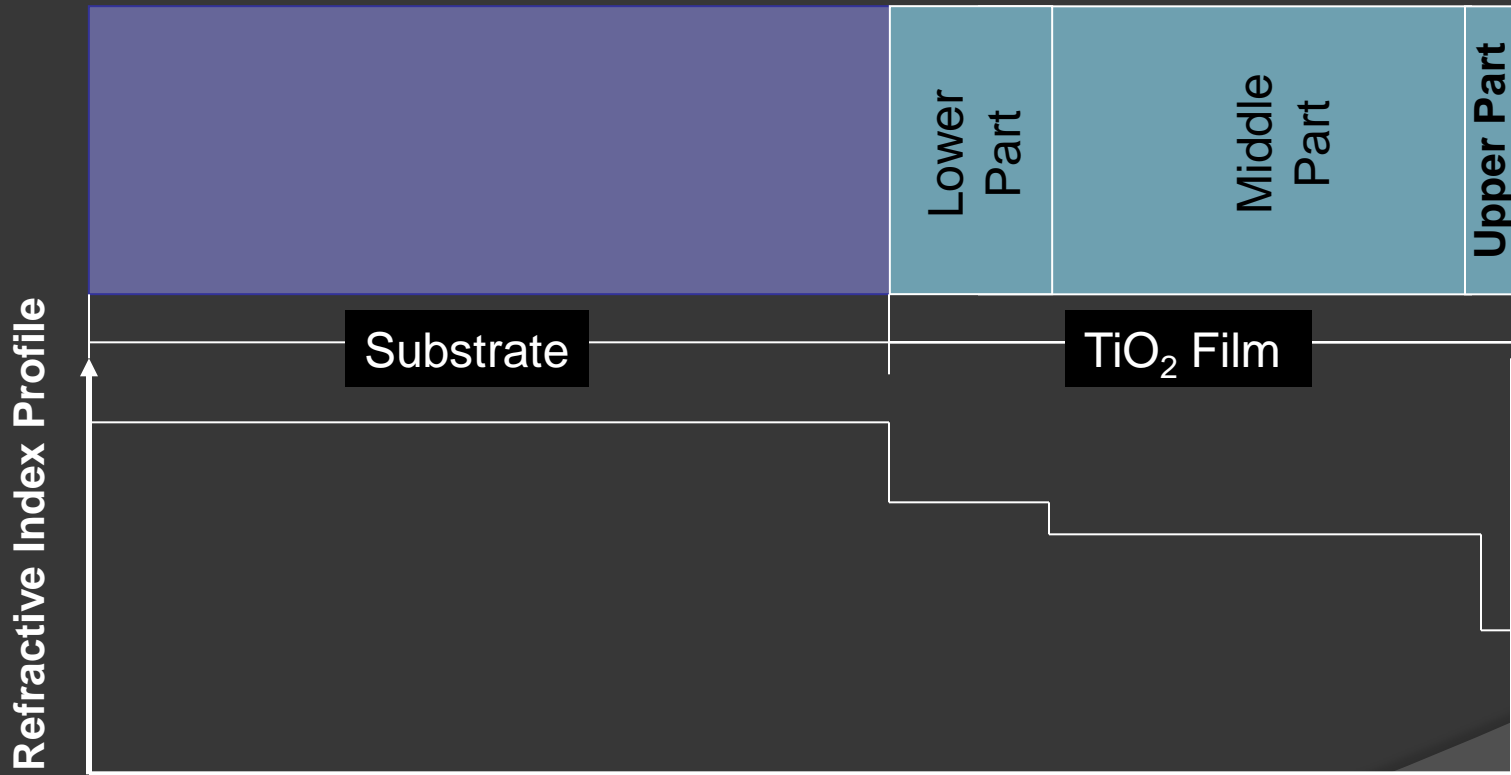
## Physical Model

*Estimated sample structure*

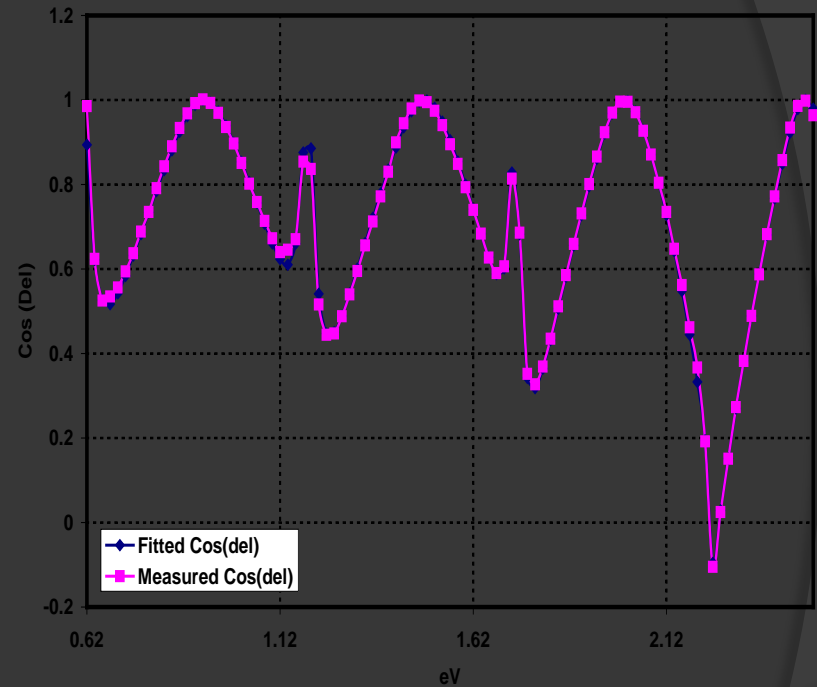
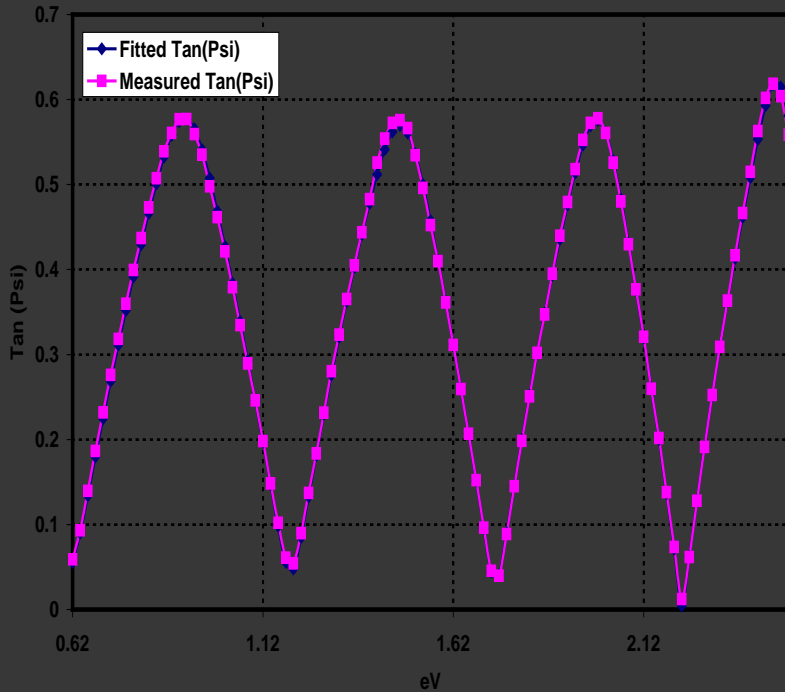
- Film Stack and structure
- Material n, k, dispersion
- Composition Fraction of Mixture



# Analysis Model

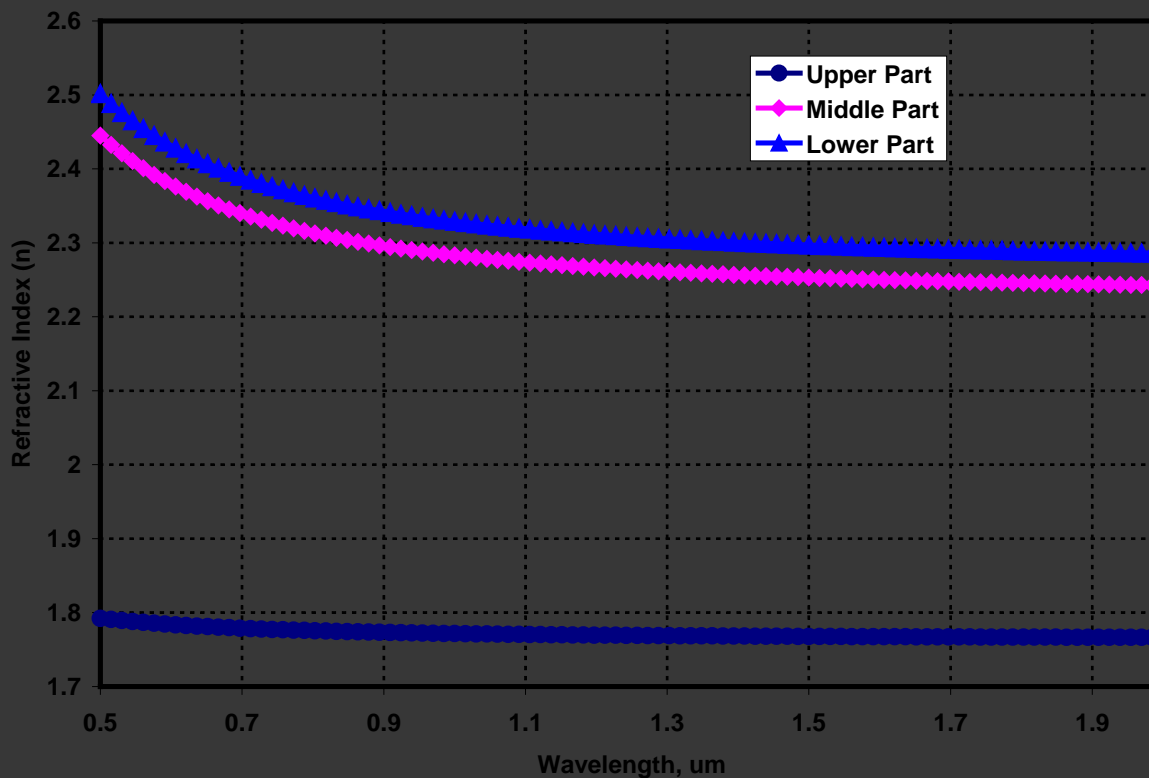


# Spectra Fittings—Three Sub-Layer Model



With the three Sub-layer model, the whole spectra can be successfully fitted for a as-deposited  $\text{TiO}_2$  film, indicating a heterogeneous structure.

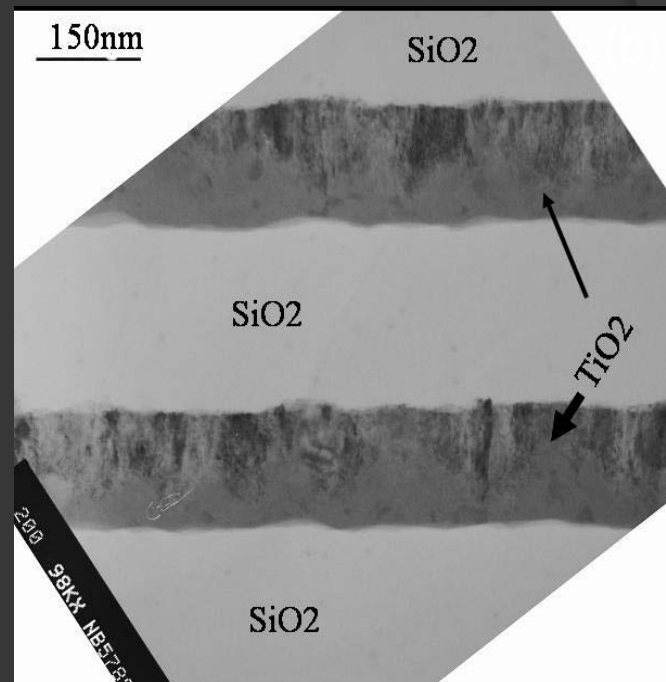
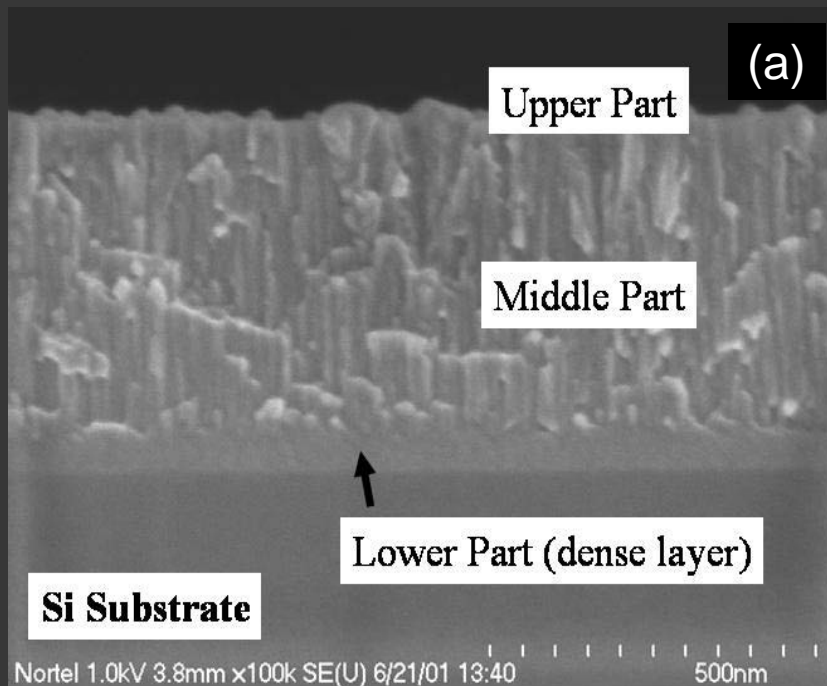
## Graded Optical Constants of TiO<sub>2</sub> Film



Ellipsometry analysis shows the gradient refractive index from the film/substrate interface to top of the film. The typical values at 1550 nm wavelength are 1.721 (upper part), 2.2363 (middle part), and 2.2825 (lower part), respectively.

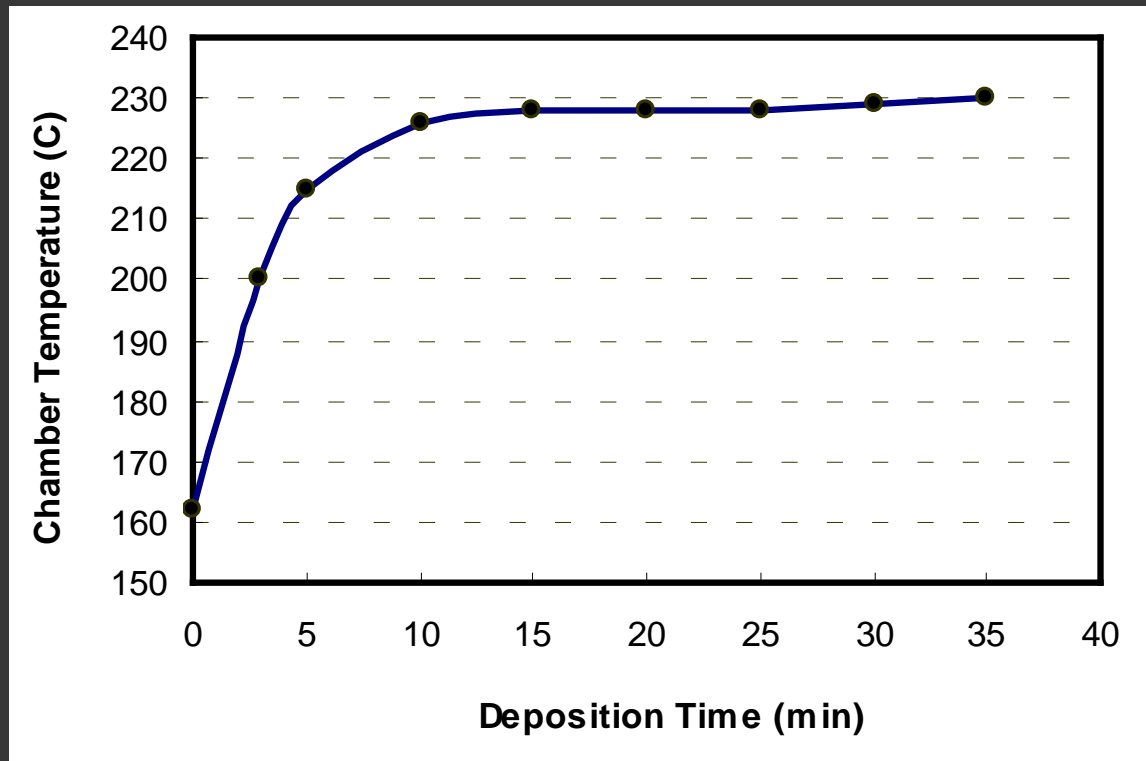


# Microscope Observation



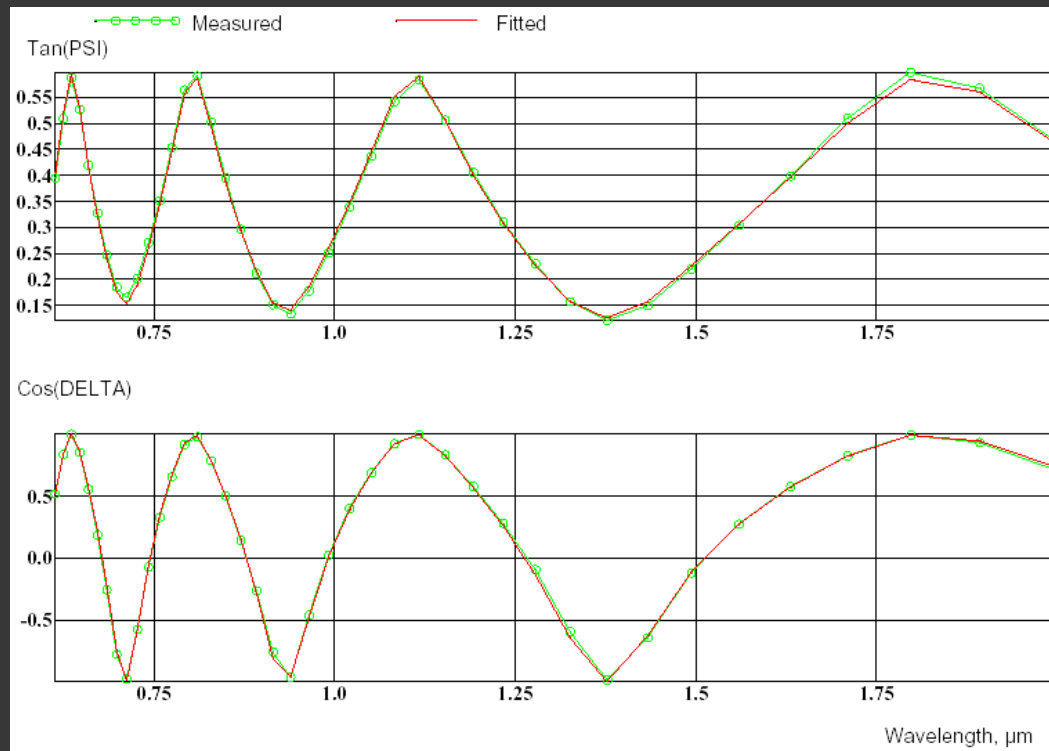
(a) SEM photo showing three sub-layers of an as-deposited TiO<sub>2</sub> film (left); (b) TEM photo for alternating SiO<sub>2</sub>/TiO<sub>2</sub> multiple layers shows the same structure for TiO<sub>2</sub> single layer (right)

## Chamber Temperature Variance



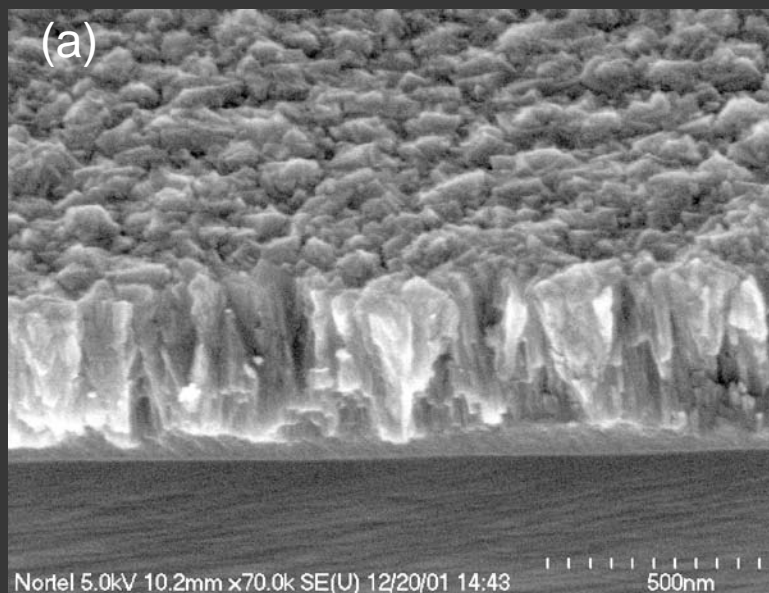
It was the temperature variance that caused the structural discrepancy of as-deposited  $\text{TiO}_2$  film.

## Co-deposited $\text{TiO}_2\text{-SiO}_2$ Film



Ellipsometry analysis shows an excellent fitting for a co-evaporated  $\text{TiO}_2\text{-SiO}_2$  film with only one layer model simulation, indicating a homogeneous structure.

## Surface Micrographs



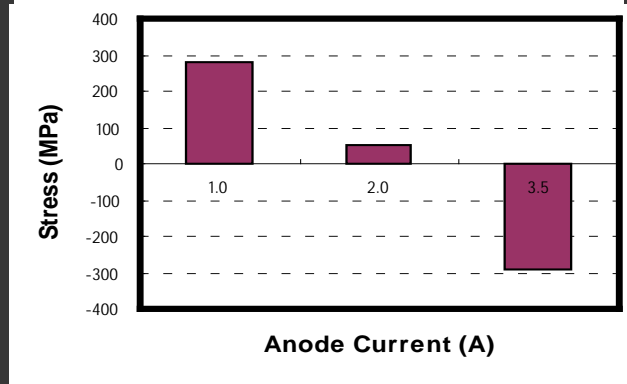
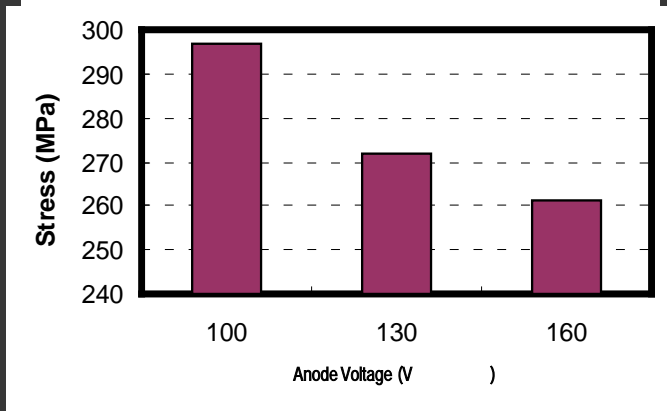
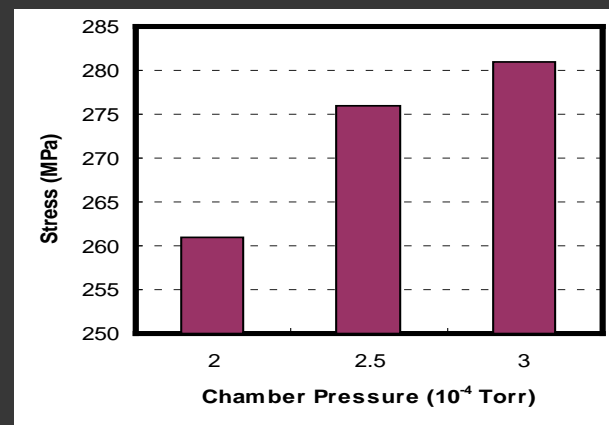
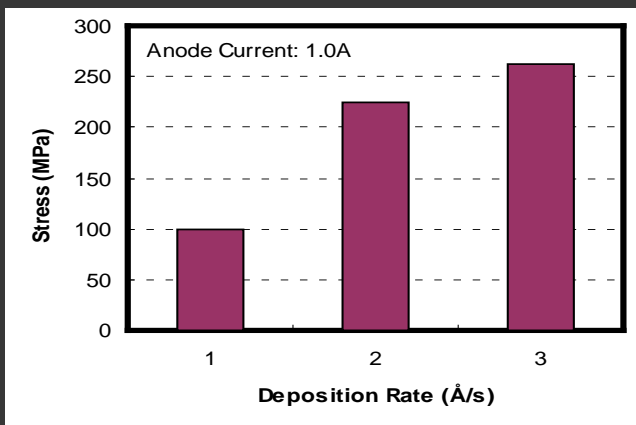
TiO<sub>2</sub> Film



Co-evaporated TiO<sub>2</sub>-SiO<sub>2</sub> Film

SEM micrographs show (a) an as-deposited TiO<sub>2</sub> film (left) and (b) a TiO<sub>2</sub>-SiO<sub>2</sub> co-evaporated film (right). AFM analysis shows that the surface roughness of pure TiO<sub>2</sub> film and co-evaporated film are 19.6 and 9.3 nm, respectively.

## TiO<sub>2</sub> Film Stress Dependency



Any process that can increase the film packing density will result in decreasing tensile stress, or increasing compressive stress. Therefore, low deposition rate, high-energy or intensive ion bombardment will produce more compressive stress for as-deposited TiO<sub>2</sub> films.



# Summary

- $\text{TiO}_2$  film stress can be tuned through properly adjusting the deposition parameters, especially anode current of the ion gun.
- Spectroscopic ellipsometry has been successfully used as a nondestructive technique to characterize the structural discrepancy of  $\text{TiO}_2$  films.
- Three sub-layer model can be used to describe the heterogeneity of as-deposited  $\text{TiO}_2$  films, which is caused mainly by the chamber temperature changes during the deposition.
- With  $\text{TiO}_2$ - $\text{SiO}_2$  co-deposition, a homogeneous film can be produced. At the same time, refractive index can be further tuned through controlling the ratio of  $\text{TiO}_2$  to  $\text{SiO}_2$  fraction in the film.

## ACKNOWLEDGEMENT

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